

Switch-mode Power Rectifiers MURS480ET3G

Ultrafast "E" Series with High Reverse Energy Capability

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- 20 mJ Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 800 V
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 217 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape & Reel, 2500 Units per Reel
- Polarity: Polarity Band on Plastic Body Indicates Cathode Lead

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|--|--------------------------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURS480E | V _{RRM} V _{RWM} V _R | 800 | > |
| Average Rectified Forward Current | I _{F(AV)} | 4.0 @ T _L =110°C | Α |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | 70 | Α |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -65 to +175 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

ULTRAFAST RECTIFIER4.0 AMPERES, 800 VOLTS



SMC 2-LEAD CASE 403AC

MARKING DIAGRAM



U4 = Specific Device Code A = Assembly Location* Y = Year

WW= Work Week

*The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------|------------------|-----------------------|
| MURS480ET3G | SMC (Pb-Free) | 2500/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MURS480ET3G

THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Maximum Thermal Resistance, Junction-to-Lead | $R_{	heta JL}$ | 11 | °C/W |
| Maximum Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 165 | °C/W |

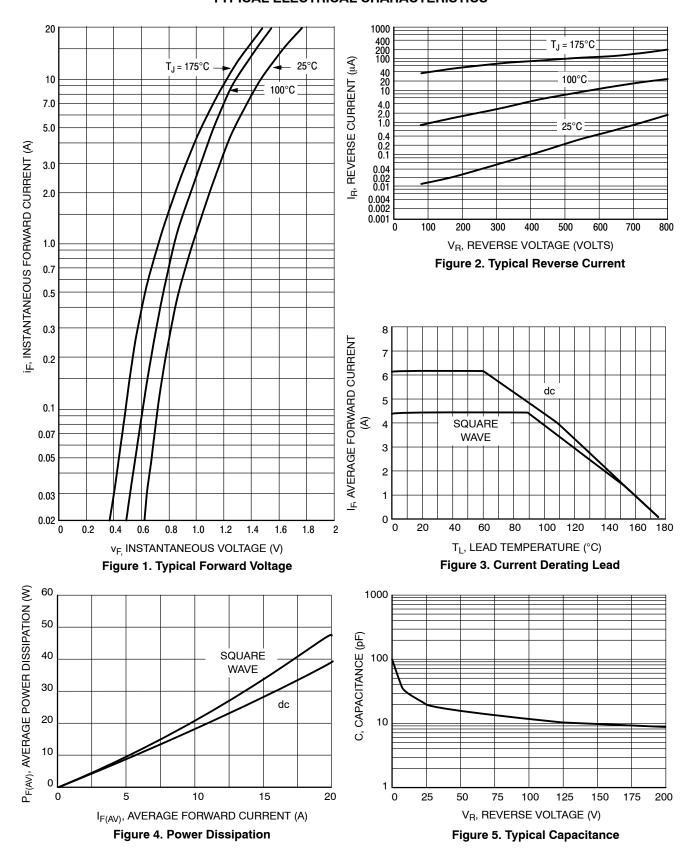
ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-------------------|----------------------|------|
| Maximum Instantaneous Forward Voltage (Note 1) $(i_F = 3.0 \text{ Amps}, T_J = 150^{\circ}\text{C})$ $(i_F = 3.0 \text{ Amps}, T_J = 25^{\circ}\text{C})$ $(i_F = 4.0 \text{ Amps}, T_J = 25^{\circ}\text{C})$ | VF | 1.53 1.75 1.85 | V |
| Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T _J = 150°C) (Rated dc Voltage, T _J = 25°C) | i _R | 900 25 | μΑ |
| Maximum Reverse Recovery Time ($I_F = 1.0 \text{ A}$, $di/dt = 50 \text{ A}/\mu\text{s}$) ($I_F = 0.5 \text{ A}$, $i_R = 1.0 \text{ A}$, $I_{REC} = 0.25 \text{ A}$) | t _{rr} | 100 75 | ns |
| Maximum Forward Recovery Time (I _F = 1.0 Amp, di/dt = 100 Amp/ μ s, Recovery to 1.0 V) | t _{fr} | 75 | ns |
| Controlled Avalanche Energy | W _{AVAL} | 20 | mJ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

MURS480ET3G

TYPICAL ELECTRICAL CHARACTERISTICS



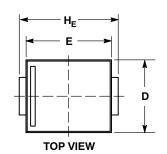


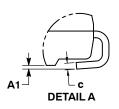


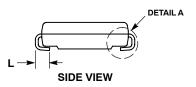


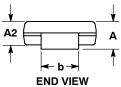
SMC 2-LEAD CASE 403AC **ISSUE B**

DATE 27 JUL 2017





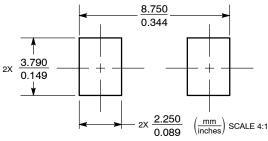




- DIMENSIONING AND TOLERANCING PER ANME Y14.5M, 1994.
- 1. DIMENSIONING AND TOLEHANGING PEH ANME Y14-5M, 1994.
 2. CONTROLLING DIMENSION: INCHES.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.254mm PER SIDE.
 4. DIMENSIONS D AND E TO BE DETERMINED AT DATUM H.
 5. DIMENSION S SHALL BE MEASURED WITHIN THE AREA
- DETERMINED BY DIMENSION L.

| | MILLIMETERS | | INC | HES |
|-----|-------------|------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 1.95 | 2.61 | 0.077 | 0.103 |
| A1 | 0.05 | 0.20 | 0.002 | 0.008 |
| A2 | 1.90 | 2.41 | 0.075 | 0.095 |
| b | 2.90 | 3.20 | 0.114 | 0.126 |
| С | 0.15 | 0.41 | 0.006 | 0.016 |
| D | 5.55 | 6.25 | 0.219 | 0.246 |
| E | 6.60 | 7.15 | 0.260 | 0.281 |
| HE | 7.75 | 8.15 | 0.305 | 0.321 |
| L | 0.75 | 1.60 | 0.030 | 0.063 |

RECOMMENDED **SOLDERING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code = Assembly Location Α

= Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

| DOCUMENT NUMBER: | 98AON97675F | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | |
|------------------|-------------|---|-------------|--|
| DESCRIPTION: | SMC 2-LEAD | | PAGE 1 OF 1 | |

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves brisefin and of 160 m are trademarked so defined values of services and of the confined values and of the values of the confined values and of the values of the confined values and of the values of the v special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales